

Interference Search

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	(lead near4 (j or gull) near4 (reverse or reversed)).clm.	US-PGPUB	OR	ON	2006/02/16 08:34
L2	0	(small near2 (area or footprint) and ((die or chip) near3 (under or underneath or above or top or bottom or below or lower or upon) near2 lead or lead-on-chip)).clm.	US-PGPUB	OR	ON	2006/02/16 08:35
L4	60	((((die or chip) near3 (under or underneath or above or top or bottom or below or lower or upon) near2 lead or lead-on-chip) and (wirebond\$3 or wire near bond\$3)).clm.	US-PGPUB	OR	ON	2006/02/16 08:37
L5	3	((((die or chip) near3 (under or underneath or above or top or bottom or below or lower or upon) near2 lead or lead-on-chip) and (wirebond\$3 or wire near bond\$3) and (lead near (foot or feet or bent or bending or j or gull or wing or l))).clm.	US-PGPUB	OR	ON	2006/02/16 08:37
S51	1	((small or reduced or decreased) near (foot or footprint) and (small or reduced or decreased or low or lower) near2 (height or profile) near15 (package or housing or leadframe or lead near frame)).clm.	US-PGPUB	OR	ON	2006/02/15 17:08
S52	7	(lead near4 (j or gull or bent) near4 (under or underneath or beneath or lower or below or bottom) near3 (housing or package or plastic or encapsulant)).clm.	US-PGPUB	OR	ON	2006/02/15 17:16
S53	4	(lead near4 (foot) near6 (inclin\$2 or angl\$2 or wettability)).clm.	US-PGPUB	OR	ON	2006/02/15 17:14